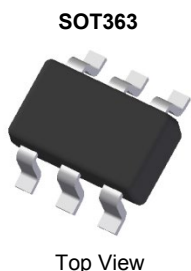


## Features

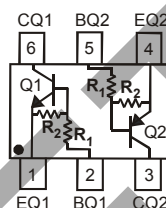
- Epitaxial Planar Die Construction
- Built-In Biasing Resistors
- Surface Mount Package Suited for Automated Assembly
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen- and Antimony-Free. “Green” Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High-Reliability**
- **PPAP Capable (Note 4)**

R1(NOM)	R2(NOM)
100kΩ	100kΩ



## Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, “Green” Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208
- Weight: 0.006 grams (Approximate)

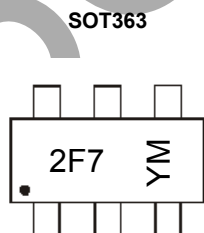


## Ordering Information (Note 6)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
ACX115EUQ-7R (Note 5)	Automotive	2F7	7	8	3,000
ACX115EUQ-13R (Note 5)	Automotive	2F7	13	8	10,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to <https://www.diodes.com/quality/>.
  5. -7R/-13R are parts rotated in the pocket tape by +180°.
  6. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



2F7 = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: F = 2018)  
 M = Month (ex: 9 = September)

### Date Code Key

Year	2018	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028
Code	F	G	H	I	J	K	L	M	N	O	P

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Absolute Maximum Ratings - NPN Section** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage <Pin: (6) to (1)>	$V_{CC}$	50	V
Input Voltage <Pin: (2) to (1)>	$V_{IN}$	-10 to 40	V
Output Current	$I_O$	20	mA
Output Current	$I_C$ (Max)	100	mA

**Absolute Maximum Ratings - PNP Section** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage <Pin: (4) to (3)>	$V_{CC}$	-50	V
Input Voltage <Pin: (5) to (4)>	$V_{IN}$	-40 to 10	V
Output Current	$I_O$	-20	mA
Output Current	$I_C$ (Max)	-100	mA

**Thermal Characteristics** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

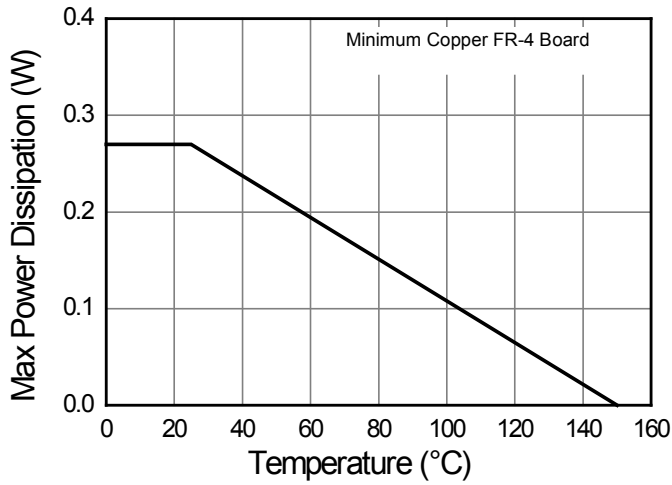
Characteristic	Symbol	Value	Unit
Power Dissipation (Notes 7 & 8)	$P_D$	270	mW
Thermal Resistance, Junction to Ambient Air (Note 7)	$R_{\theta JA}$	450	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ\text{C}$

Notes: 7. Mounted on FR-4 PC Board with minimum recommended pad layout.  
8. 150mW per element must not be exceeded.

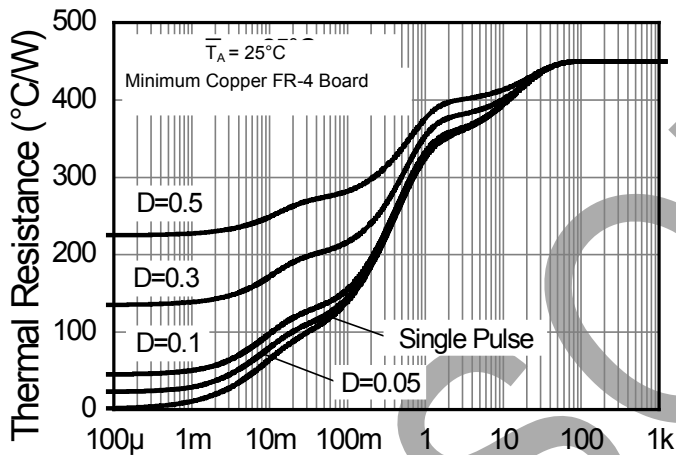
**OBSOLETE - PART DISCONTINUED**
**OBSOLETE**

OBSOLETE - PART DISCONTINUED

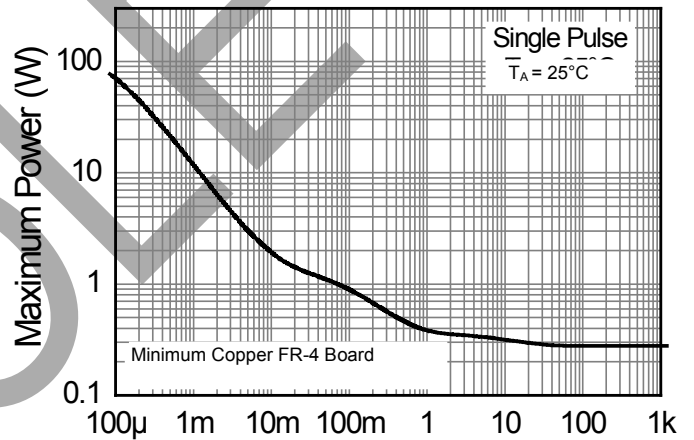
**Thermal Characteristics and Derating Information**



**Derating Curve**



**Transient Thermal Impedance**



**Pulse Power Dissipation**

**Electrical Characteristics - NPN Section** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Input Voltage	$V_{I(OFF)}$ (Note 9)	0.5	—	—	V	$V_{CC} = 5V, I_O = 100\mu\text{A}$
	$V_{I(ON)}$ (Note 10)	—	—	3.0		$V_O = 0.3V, I_O = 1\text{mA}$
Output Voltage	$V_{O(ON)}$	—	0.1	0.3	V	$I_O/I_I = 10\text{mA} / 0.5\text{mA}$
Input Current	$I_I$	—	—	0.15	mA	$V_I = 5V$
Output Current	$I_{O(OFF)}$	—	—	0.5	$\mu\text{A}$	$V_{CC} = 50V, V_I = 0V$
DC Current Gain	$G_I$	82	—	—	—	$V_O = 5V, I_O = 5\text{mA}$
Input Resistor ( $R_1$ ) Tolerance	$\Delta R_1$	-30	—	30	%	—
Resistance Ratio Tolerance	$\Delta R_2/R_1$	-20	—	20	%	—
Gain-Bandwidth Product (Note 11)	$f_T$	—	250	—	MHz	$V_{CE} = 10V, I_E = 5\text{mA}, f = 100\text{MHz}$

Notes: 9. Guarantees that the device will be switched OFF if the Input Voltage is less than 0.5V.

10. Guarantees that the device will be switched ON if the Input Voltage is more than 3V.

11. Transistor - For Reference Only.

**Electrical Characteristics - PNP Section** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

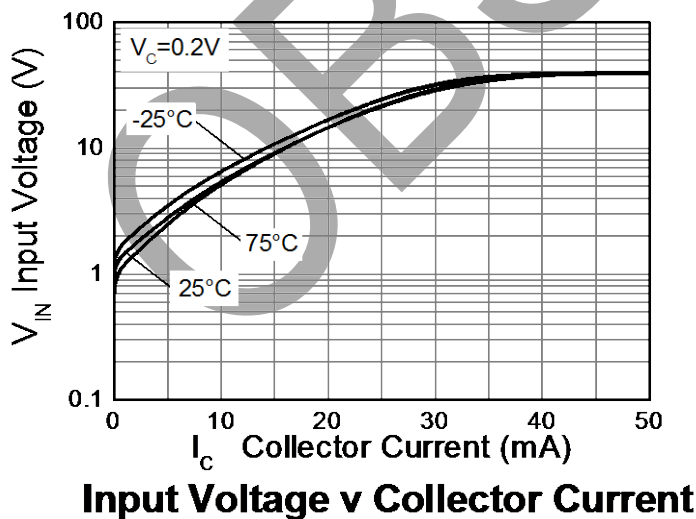
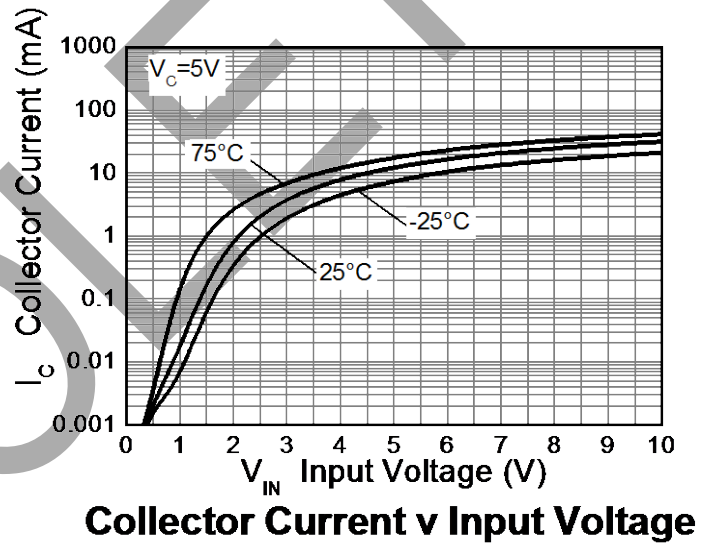
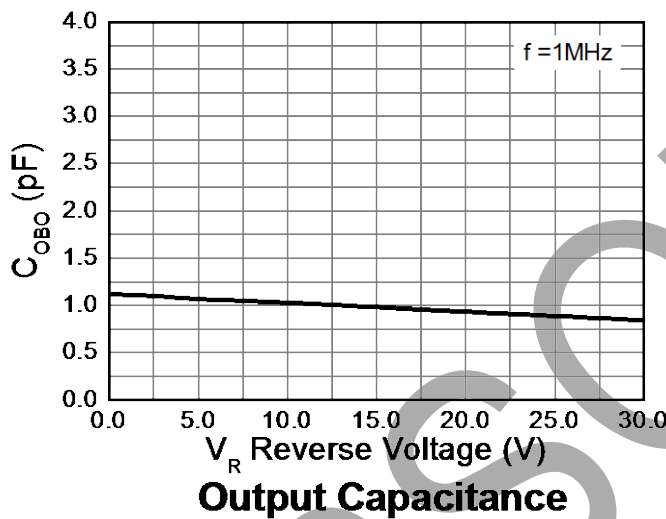
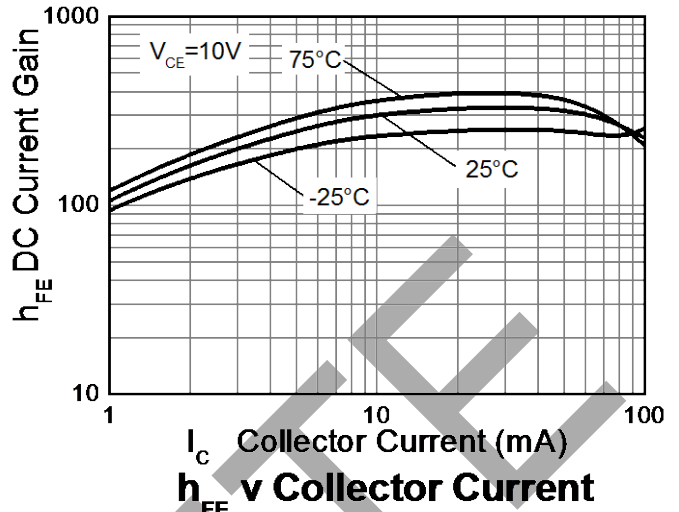
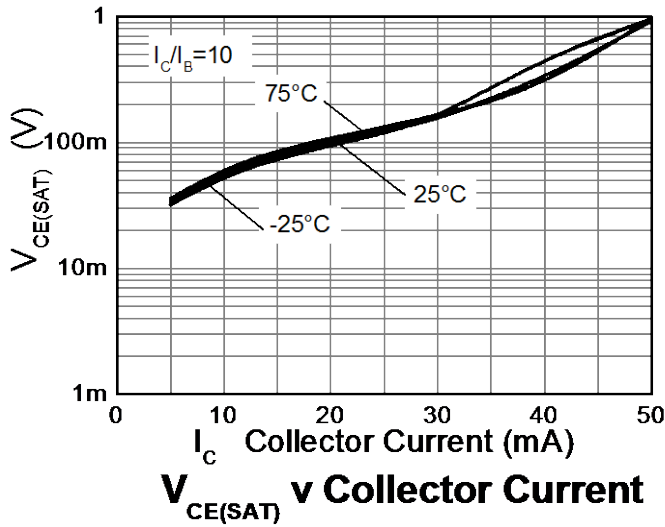
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Input Voltage	$V_{I(OFF)}$ (Note 12)	-0.5	—	—	V	$V_{CC} = -5V, I_O = -100\mu\text{A}$
	$V_{I(ON)}$ (Note 13)	—	—	-3.0		$V_O = -0.3V, I_O = -1\text{mA}$
Output Voltage	$V_{O(ON)}$	—	-0.1	-0.3	V	$I_O/I_I = -10\text{mA} / -0.5\text{mA}$
Input Current	$I_I$	—	—	-0.15	mA	$V_I = -5V$
Output Current	$I_{O(OFF)}$	—	—	-0.5	$\mu\text{A}$	$V_{CC} = -50V, V_I = 0V$
DC Current Gain	$G_I$	82	—	—	—	$V_O = -5V, I_O = -5\text{mA}$
Input Resistor ( $R_1$ ) Tolerance	$\Delta R_1$	-30	—	30	%	—
Resistance Ratio Tolerance	$\Delta R_2/R_1$	-20	—	20	%	—
Gain-Bandwidth Product (Note 11)	$f_T$	—	250	—	MHz	$V_{CE} = -10V, I_E = -5\text{mA}, f = 100\text{MHz}$

Notes: 12. Guarantees that the device will be switched OFF if the Input Voltage is less than -0.5V.

13. Guarantees that the device will be switched ON if the Input Voltage is more than -3V.

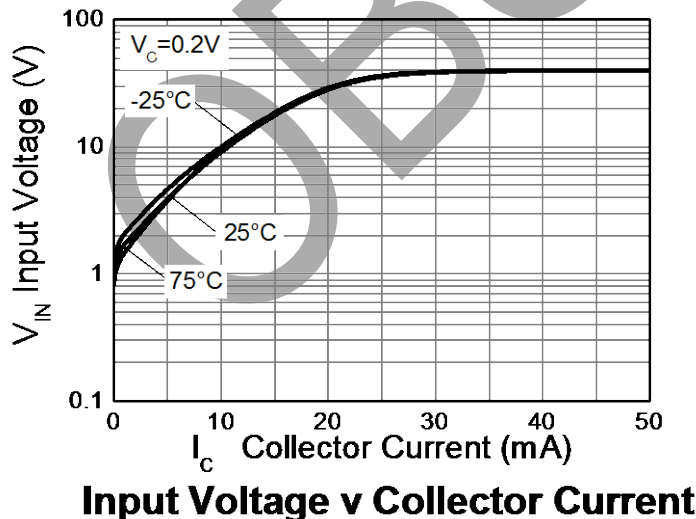
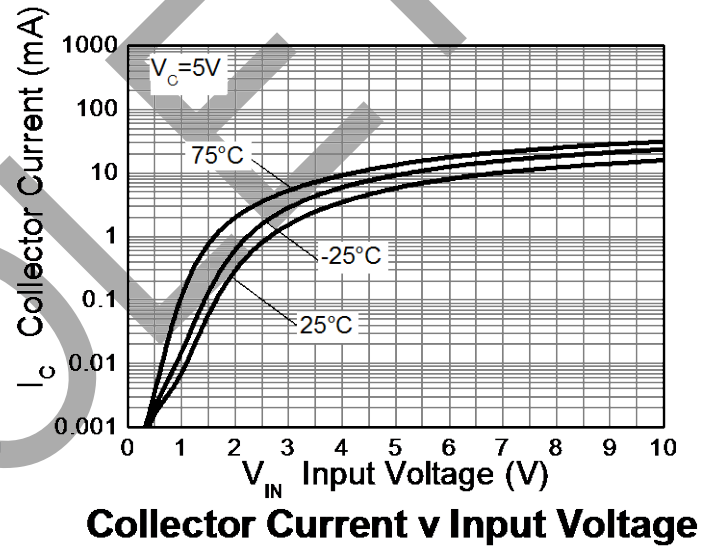
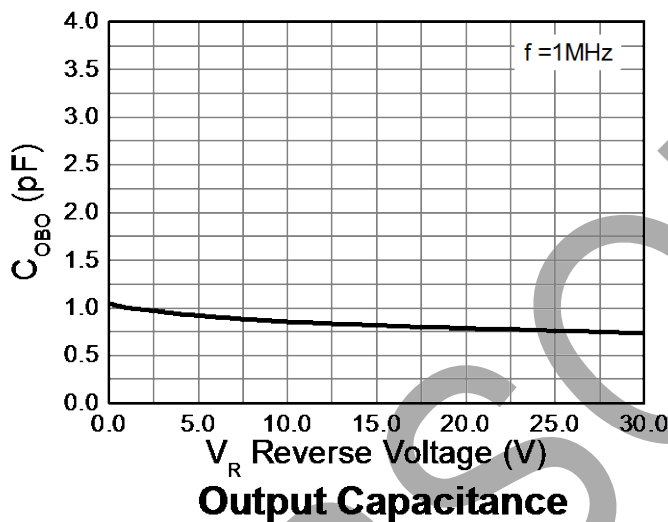
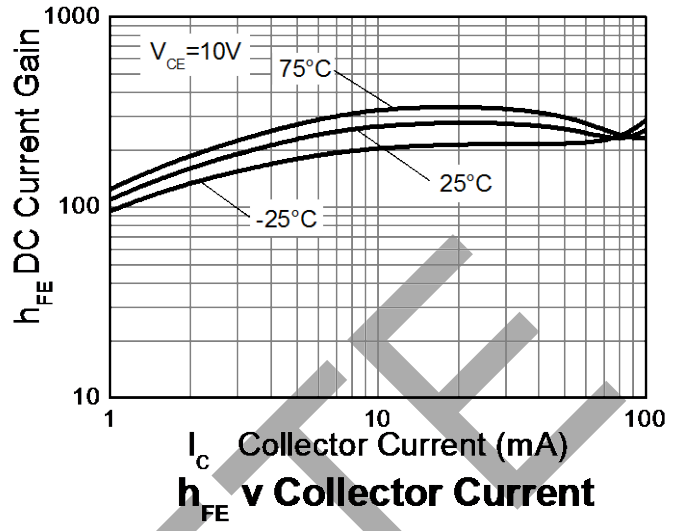
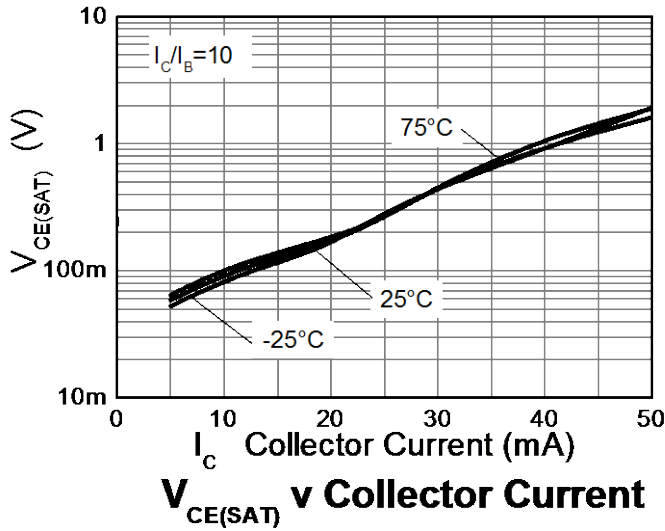
OBSOLETE

**Typical Electrical Characteristics – NPN Section** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)



OBSOLETE – PART DISCONTINUED

**Typical Electrical Characteristics – PNP Section** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

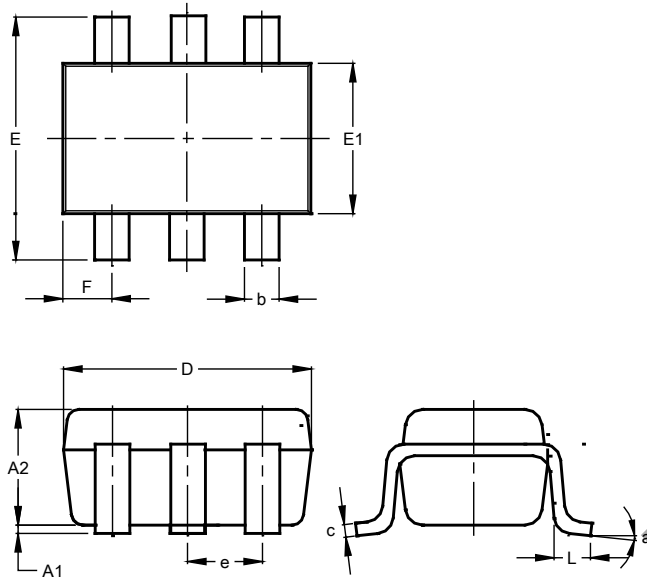


OBSOLETE – PART DISCONTINUED

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT363

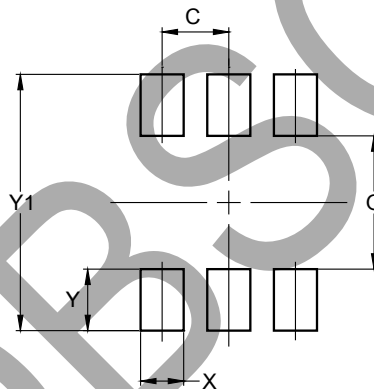


SOT363			
Dim	Min	Max	Typ
A1	0.00	0.10	0.05
A2	0.90	1.00	0.95
b	0.10	0.30	0.25
c	0.10	0.22	0.11
D	1.80	2.20	2.15
E	2.00	2.20	2.10
E1	1.15	1.35	1.30
e	0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
a	0°	8°	--
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT363



Dimensions	Value (in mm)
C	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500

OBSOLETE - PART DISCONTINUED

**IMPORTANT NOTICE**

1. DIODES INCORPORATED AND ITS SUBSIDIARIES ("DIODES") MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).
2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes products. Diodes products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of the Diodes products for their intended applications, (c) ensuring their applications, which incorporate Diodes products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.
3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.
4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.
5. Diodes products are provided subject to Diodes' Standard Terms and Conditions of Sale (<https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/>) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.
6. Diodes products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.
7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.
8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.

Copyright © 2021 Diodes Incorporated

[www.diodes.com](http://www.diodes.com)

OBsolete - PART DISCONTINUED